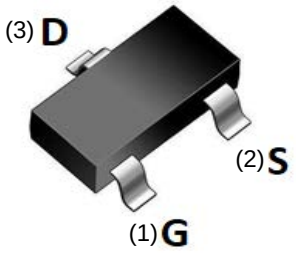
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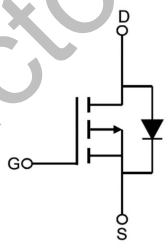
Features:

- ☐ Advanced Trench Technology.
- ☐ Excellent Switching Characteristics.
- ☐ Extended Safe Operating Area.
- ☐ Unrivalled Gate Charge :Qg= 23 nC (Typ.).
- ☐ BVDSS= -40V,ID= -6A
- ☐ RDS(on) : 50mΩ (Typ.) @VG=10V
- ☐ 100% Avalanche Tested

SOT-23-3L



1:Gate (G)
2:Source (S)
3:Drain (D)



Schematic diagram

Absolute Maximum Ratings (T_A=25℃ unless otherwise specified)

Symbol	Parameter		Value	Units
V_{DS}	Drain-to-Source Voltage		-40	V
V_{GS}	Gate-to-Source Voltage		±20	V
I_D	Continuous Drain Current	T_A = 25°C	-6	A
		T_A = 100°C	-4	
I_{DM}	Pulsed Drain Current (1)		-24	A
E_{AS}	Single Pulsed Avalanche Energy (2)		25	mJ
P_D	Power Dissipation	T_A = 25°C	1.7	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient(3)		76	°C/W
T_J, T_{STG}	Junction & Storage Temperature Range		-55 to 150	°C

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Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
Off Characteristics						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	I_D = -250μA, V_{GS} = 0V	-40	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = -40V, V_{GS} = 0V	-	-	-1.0	μA
I_{GSS}	Gate-Body Leakage Current	V_{DS} = 0V, V_{GS} = ±20V	-	-	±100	nA
On Characteristics						
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} = V_{GS}, I_D = -250μA	-1.0	-1.7	-2.5	V
$R_{DS(ON)}$	Static Drain-Source ON-Resistance(4)	V_{GS} = -10V, I_D = -6A	-	50	60	mΩ
		V_{GS} = -4.5V, I_D = -4A	-	60	76	mΩ
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{GS} = 0V, V_{DS} = -20V, f = 1MHz	-	1244	-	pF
C_{oss}	Output Capacitance		-	97	-	pF
C_{rss}	Reverse Transfer Capacitance		-	80	-	pF
Q_g	Total Gate Charge	V_{GS} = 0 to -10V, V_{DS} = -20V, I_D = -5A	-	23	-	nC
Q_{gs}	Gate Source Charge		-	4	-	nC
Q_{gd}	Gate Drain("Miller") Charge		-	4	-	nC
Switching Characteristics						
$t_{d(on)}$	Turn-On DelayTime	V_{GS} = -10V, V_{DD} = -20V, I_D= -5A, R_{GEN} = 3Ω	-	5	-	ns
t_r	Turn-On Rise Time		-	2	-	ns
$t_{d(off)}$	Turn-Off DelayTime		-	51	-	ns
t_f	Turn-Off Fall Time		-	29	-	ns
Drain-Source Diode Characteristics and Max Ratings						
I_S	Maximum Continuous Drain to Source Diode Forward Current		-	-	-6	A
I_{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	-24	A
V_{SD}	Drain to Source Diode Forward Voltage	V_{GS} = 0V, I_S = -6A	-	-	-1.2	V
trr	Body Diode Reverse Recovery Time	I_F = -5A, di/dt = 100A/us	-	13	-	ns
Qrr	Body Diode Reverse Recovery Charge		-	7	-	nC

Notes: 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

2. E_{AS} condition: Starting T_J=25C, V_{DD}=-20V, V_G=-10V, R_G=25ohm, L=0.5mH, I_{AS}=-10A

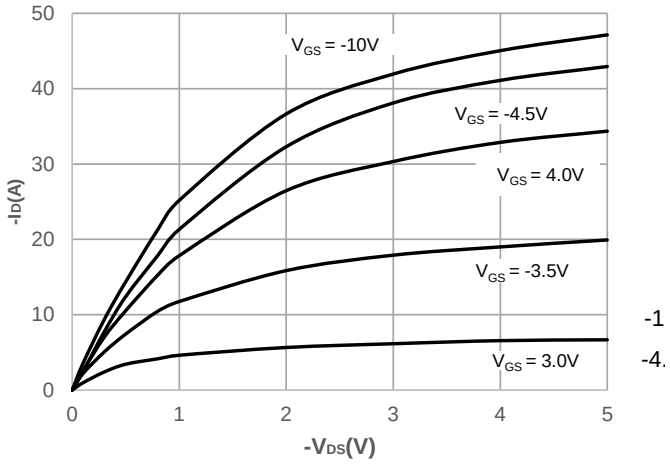
3. $R_{\theta JA}$ is measured with the device mounted on a 1inch^2 pad of 2oz copper FR4 PCB

4. Pulse Test: Pulse Width≤300μs, Duty Cycle≤0.5%.

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Typical Performance Characteristics

Figure 1: Output Characteristics



-1

-4.

Figure 2: Typical Transfer Characteristics

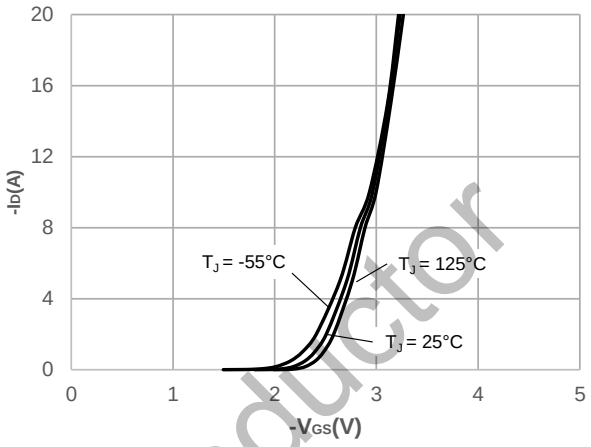


Figure 3: On-resistance vs. Drain Current

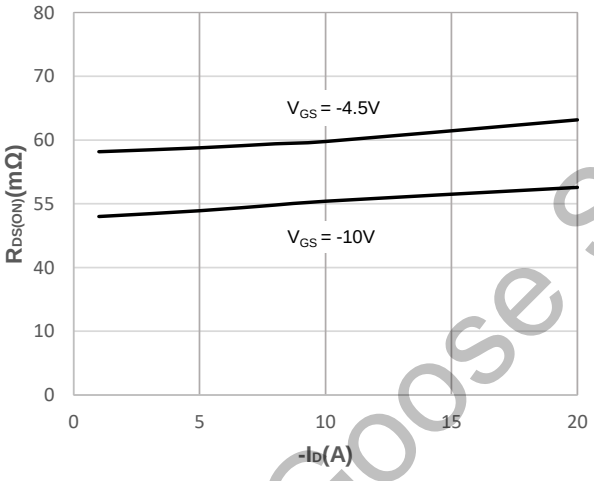


Figure 4: Body Diode Characteristics

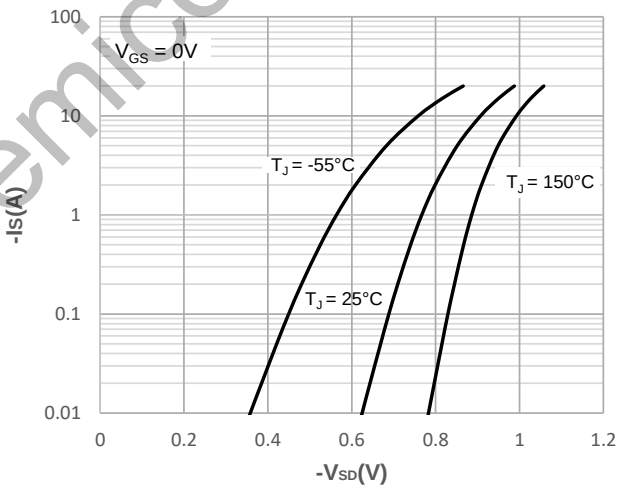


Figure 5: Gate Charge Characteristics

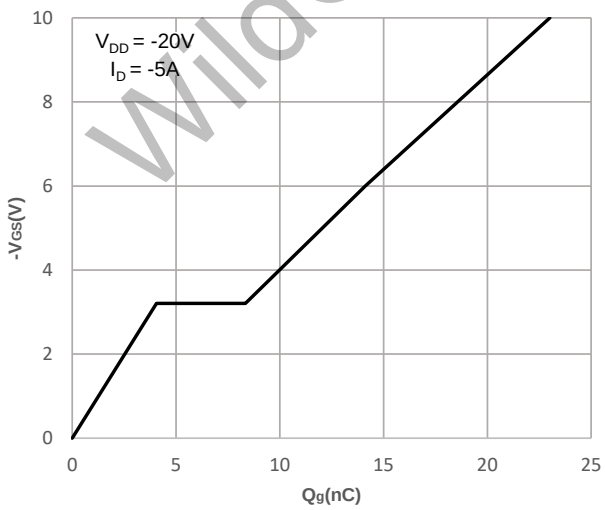
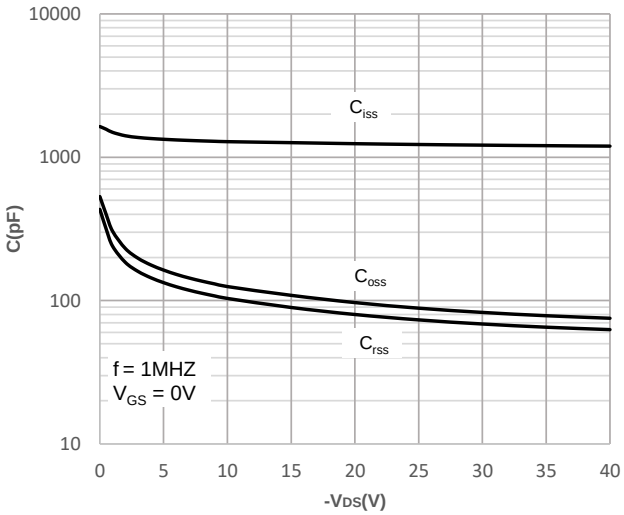


Figure 6: Capacitance Characteristics



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Typical Performance Characteristics

Figure 7: Normalized Breakdown voltage vs. Junction Temperature

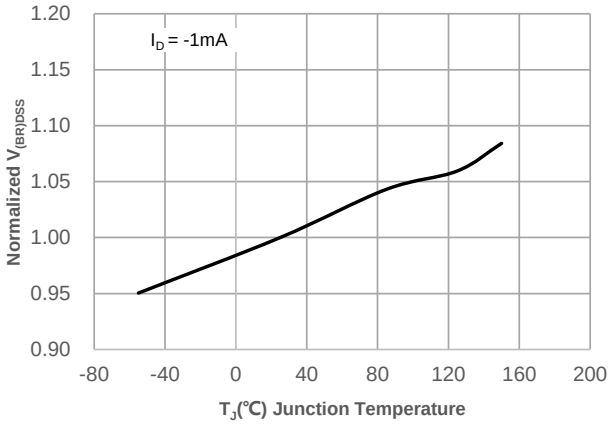


Figure 8: Normalized on Resistance vs. Junction Temperature

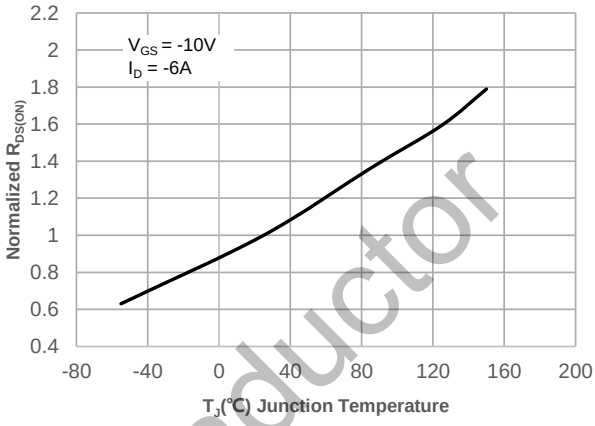


Figure 9: Maximum Safe Operating Area

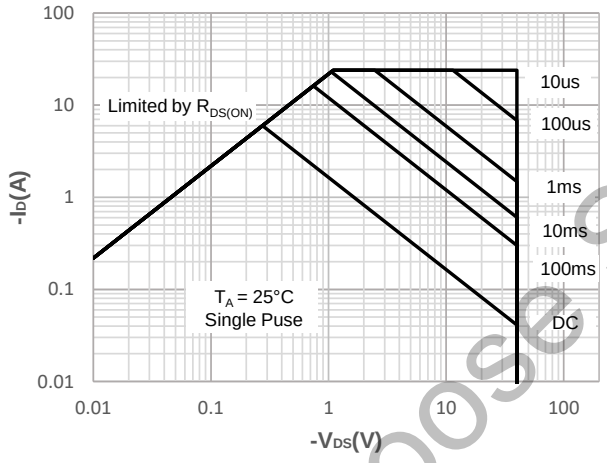


Figure 10: Maximum Continuous Drian Current vs. Ambient Temperature

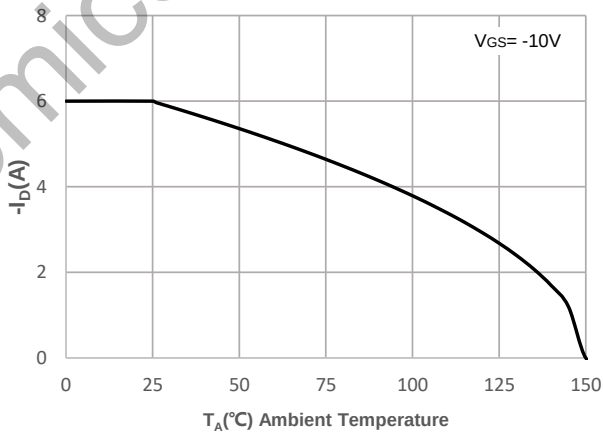


Figure 11: Normalized Maximum Transient Thermal Impedance

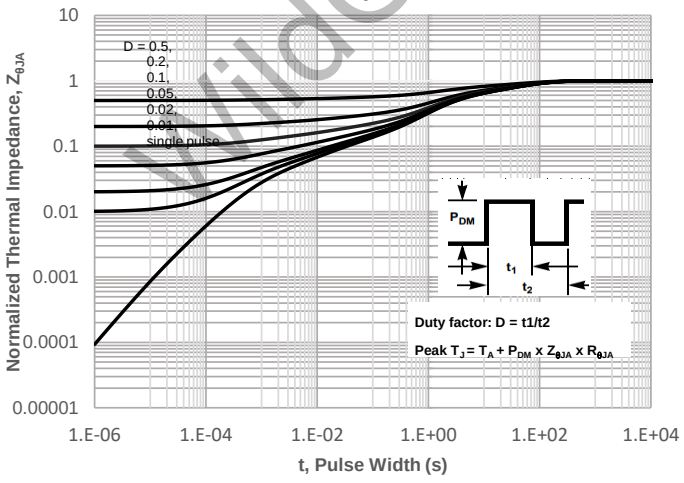
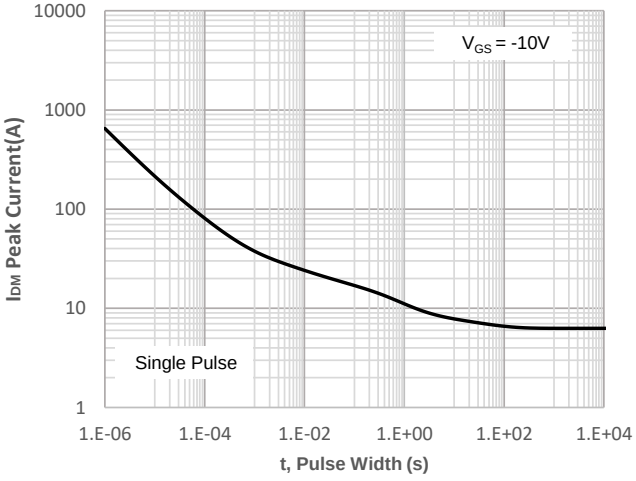


Figure 12: Peak Current Capacity



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Test Circuit

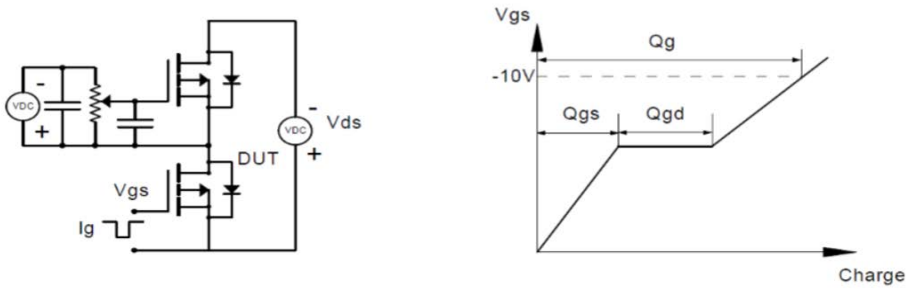


Figure 1: Gate Charge Test Circuit & Waveform

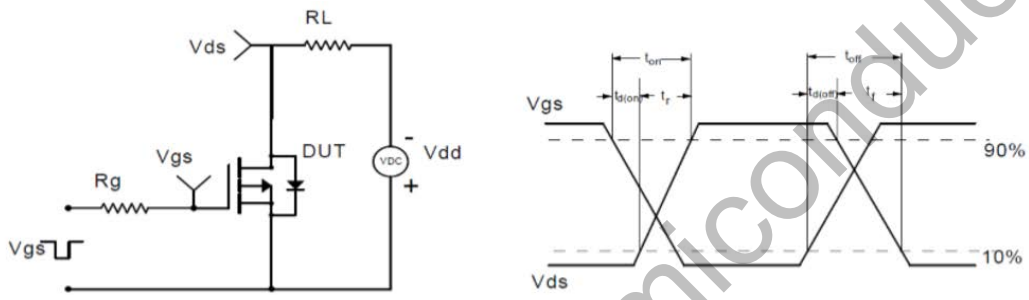


Figure 2: Resistive Switching Test Circuit & Waveform

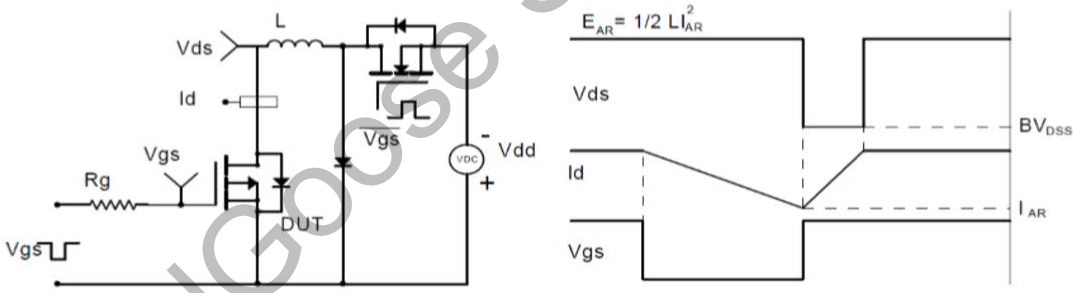


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

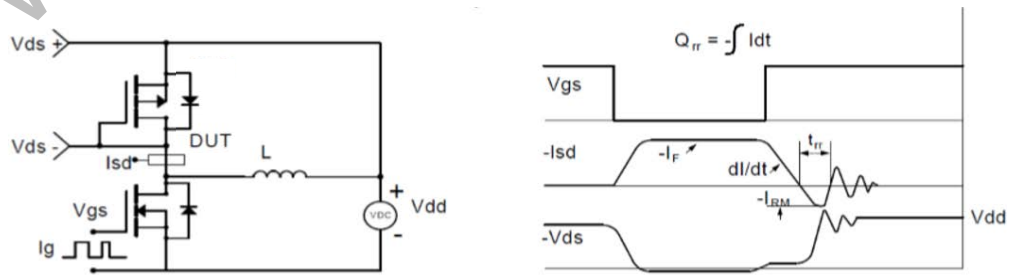


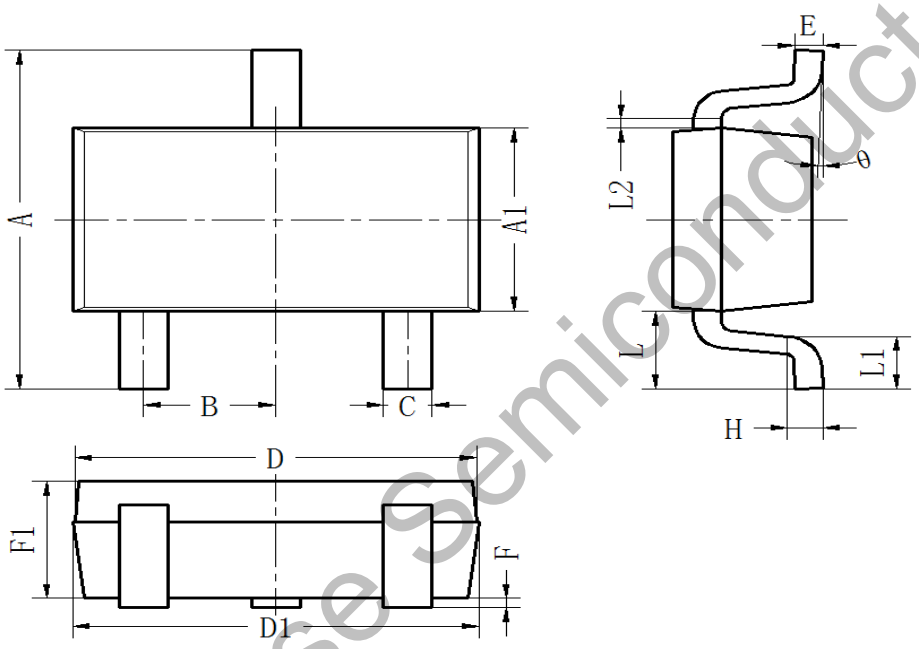
Figure 4: Diode Recovery Test Circuit & Waveform

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Package Dimension

SOT-23-3L

Unit: mm



符号	标准	下公差	上公差	下限值		上限值	
				内控	放行	内控	放行
A	2.8	-0.15	0.15	2.68	2.65	2.92	2.95
A1	1.6	-0.1	0.1	1.52	1.5	1.68	1.7
B	0.95	-0.05	0.05	0.91	0.90	0.99	1.00
C	0.4	-0.1	0.1	0.32	0.3	0.45	0.5
D	2.92	-0.1	0.1	2.84	2.82	3.00	3.02
D1	2.92	-0.05	0.05	2.88	2.87	2.96	2.97
E	0.15	-0.05	0.05	0.11	0.1	0.19	0.2
H	0.254	-0.05	0.05	0.214	0.204	0.294	0.304
L	0.65	-0.1	0.1	0.57	0.55	0.73	0.75
L1	0.45	-0.15	0.15	0.33	0.3	0.57	0.6
L2	0.08	-0.02	0.02	0.06	0.06	0.10	0.10
θ	/	/	/	/	0	/	8
F1	1.1	-0.05	0.05	1.06	1.05	1.14	1.15
F	0.08	-0.04	0.04	0.05	0.04	0.11	0.12

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